



3NM90

Preliminary

Power MOSFET

3A, 900V N-CHANNEL SUPER-JUNCTION MOSFET

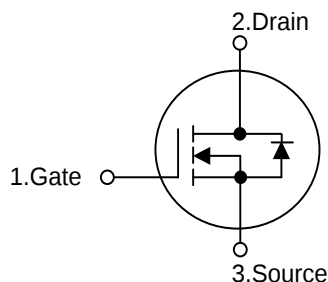
DESCRIPTION

The UTC 3NM90 is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at AC-DC converters for power applications.

FEATURES

- * $R_{DS(ON)} \leq 4.9 \Omega$ @ $V_{GS}=10V$, $I_D=1.5A$
- * Fast switching capability
- * Avalanche energy tested
- * Improved dv/dt capability, high ruggedness

SYMBOL

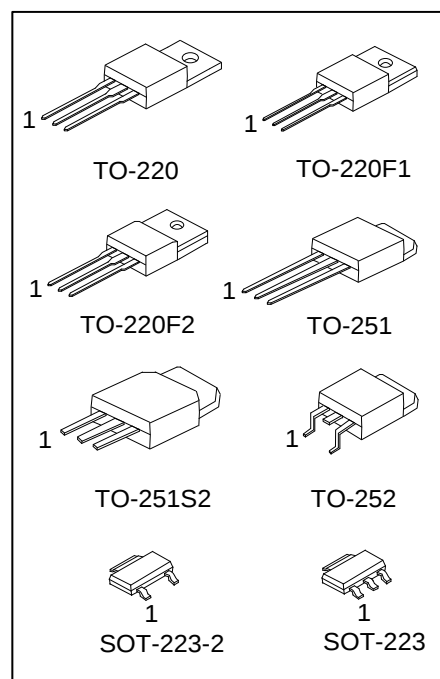


ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	5	
3NM90L-AA2-R	3NM90G-AA2-R	SOT-223-2	G	D	S	Tape Reel
3NM90L-AA3-R	3NM90G-AA3-R	SOT-223	G	D	S	Tape Reel
3NM90L-TA3-T	3NM90G-TA3-T	TO-220	G	D	S	Tube
3NM90L-TF1-T	3NM90G-TF1-T	TO-220F1	G	D	S	Tube
3NM90L-TF2-T	3NM90G-TF2-T	TO-220F2	G	D	S	Tube
3NM90L-TM3-T	3NM90G-TM3-T	TO-251	G	D	S	Tube
3NM90L-TMS2-T	3NM90G-TMS2-T	TO-251S2	G	D	S	Tube
3NM90L-TN3-R	3NM90G-TN3-R	TO-252	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

3NM90G-AA3-R (1) Packing Type (2) Package Type (3) Green Package	(1) R: Tape Reel, T: Tube (2) AA2: SOT-223-2, AA3: SOT-223, TA3: TO-220, TF1: TO-220F1, TF2: TO-220F2, TM3: TO-251, TMS2: TO-251S2, TN3: TO-252 (3) G: Halogen Free and Lead Free, L: Lead Free
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MARKING

SOT-223-2 / SOT-223	TO-220 / TO-220F1 / TO-220F2 TO-251 / TO-251S2 / TO-252
3NM90 1 L: Lead Free G: Halogen Free Date Code	UTC 3NM90 1 Lot Code L: Lead Free G: Halogen Free Date Code

■ **ABSOLUTE MAXIMUM RATINGS** ($T_C = 25^\circ\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	900	V
Gate-Source Voltage		V_{GSS}	± 30	V
Continuous Drain Current	Continuous	I_D	3.0	A
Pulsed Drain Current	Pulsed (Note 2)	I_{DM}	12	A
Avalanche Current (Note 2)		I_{AR}	1.1	A
Single Pulsed Avalanche Energy	Single Pulsed (Note 5)	E_{AS}	96	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	1.17	V/ns
Power Dissipation	SOT-223-2/SOT-223	P_D	2.5	W
	TO-220		37	W
	TO-220F1/TO-220F2		21	W
	TO-251/TO-251S2		22	W
	TO-252			
Junction Temperature		T_J	+150	$^\circ\text{C}$
Storage Temperature		T_{STG}	-55 ~ +150	$^\circ\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

5. $L = 159\text{mH}$, $I_{AS} = 1.1\text{A}$, $V_{DD} = 50\text{V}$, $R_G = 25\Omega$, Starting $T_J = 25^\circ\text{C}$.

4. $I_{SD} \leq 2.0\text{A}$, $di/dt \leq 200\text{A}/\mu\text{s}$, $V_{DD} \leq BV_{DSS}$, Starting $T_J = 25^\circ\text{C}$.

■ **THERMAL DATA**

PARAMETER		SYMBOL	RATING	UNIT
Junction to Ambient	SOT-223-2/SOT-223	θ_{JA}	150	$^\circ\text{C/W}$
	TO-220/TO-220F1		62.5	$^\circ\text{C/W}$
	TO-220F2			
	TO-251/TO-251S2 TO-252		110	$^\circ\text{C/W}$
Junction to Case	SOT-223-2/SOT-223	θ_{JC}	50 (Note)	$^\circ\text{C/W}$
	TO-220		3.38	$^\circ\text{C/W}$
	TO-220F1/TO-220F2		5.95	$^\circ\text{C/W}$
	TO-251/TO-251S2		5.68 (Note)	$^\circ\text{C/W}$
	TO-252			

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

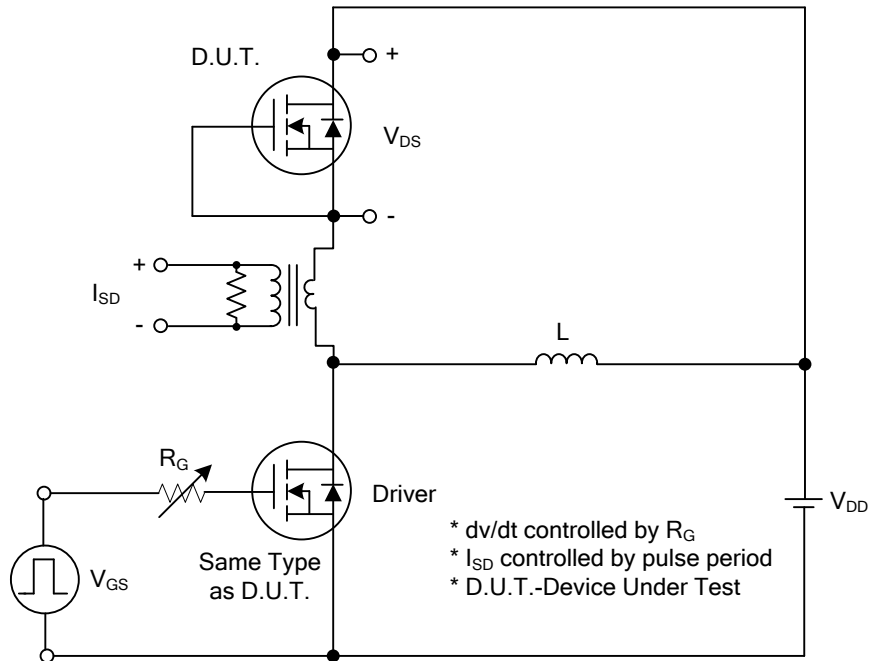
■ **ELECTRICAL CHARACTERISTICS** ($T_J = 25^\circ\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV _{DSS}	V _{GS} = 0V, I _D = 250μA	900			V
Drain-Source Leakage Current		I _{DSS}	V _{DS} = 900V, V _{GS} = 0V			10	μA
Gate-Source Leakage Current	Forward	I _{GSS}	V _{GS} = 30V, V _{DS} = 0V			100	nA
	Reverse		V _{GS} = -30V, V _{DS} = 0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		V _{GS(TH)}	V _{DS} = V _{GS} , I _D = 250μA	2.5		4.5	V
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} = 10V, I _D = 1.5A			4.9	Ω
DYNAMIC CHARACTERISTICS							
Input Capacitance		C _{ISS}	V _{GS} =0V, V _{DS} =25V, f=1.0MHz		235		pF
Output Capacitance		C _{OSS}			110		pF
Reverse Transfer Capacitance		C _{RSS}			6		pF
SWITCHING CHARACTERISTICS							
Total Gate Charge (Note 1)		Q _G	V _{DS} =50V, I _D =1.3A, I _G =100μA V _{GS} =10V (Note 1,2)		40		nC
Gate to Source Charge		Q _{GS}			3.5		nC
Gate to Drain Charge		Q _{GD}			8		nC
Turn-ON Delay Time (Note 1)		t _{D(ON)}	V _{DD} =30V, I _D =0.5A, R _G =25Ω, V _{GS} =10V (Note 1,2)		42		nS
Rise Time		t _R			50		nS
Turn-OFF Delay Time		t _{D(OFF)}			115		nS
Fall-Time		t _F			32		nS
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS							
Maximum Body-Diode Continuous Current		I _S				3	A
Maximum Body-Diode Pulsed Current		I _{SM}				12	A
Drain-Source Diode Forward Voltage (Note 1)		V _{SD}	I _S =3.0A, V _{GS} =0V			1.4	V
Body Diode Reverse Recovery Time (Note 1)		t _{rr}	I _S =3.0A, V _{GS} =0V,		470		nS
Body Diode Reverse Recovery Charge		Q _{rr}	dl _F /dt=100A/μs		2.9		μC

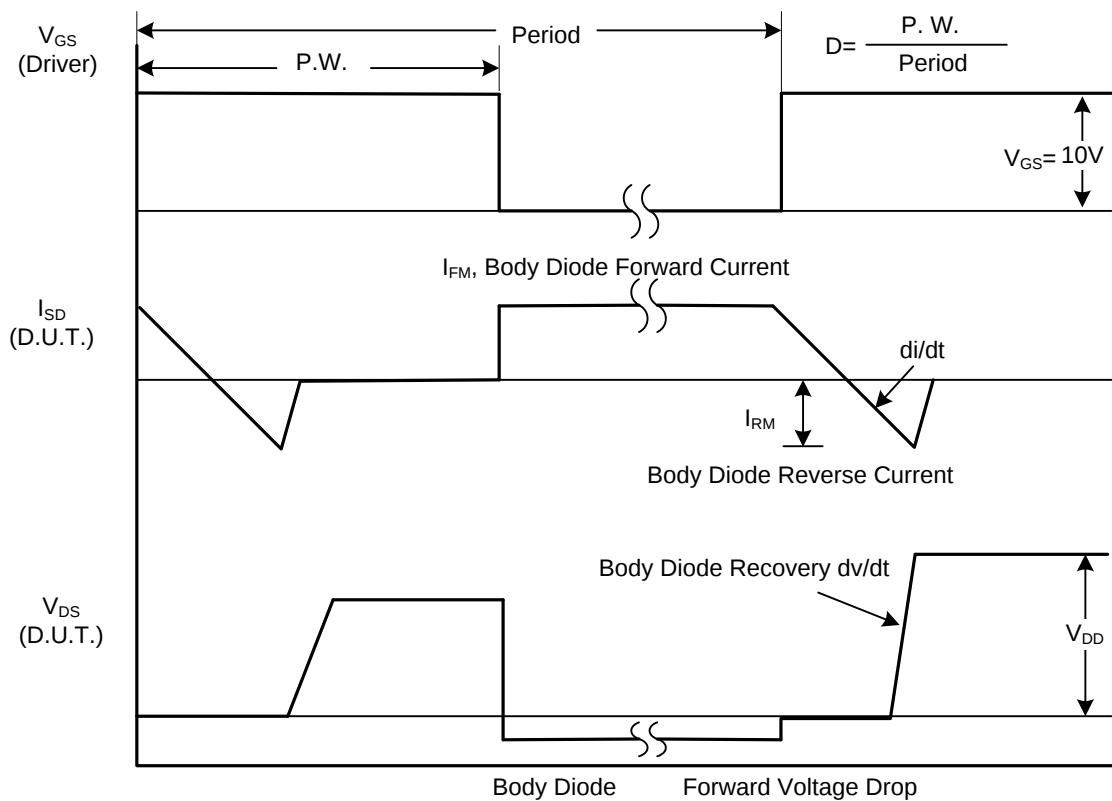
Notes: 1. Pulse Test : Pulse width $\leq 300\mu s$, Duty cycle $\leq 2\%$.

2. Essentially independent of operating ambient temperature.

■ TEST CIRCUITS AND WAVEFORMS

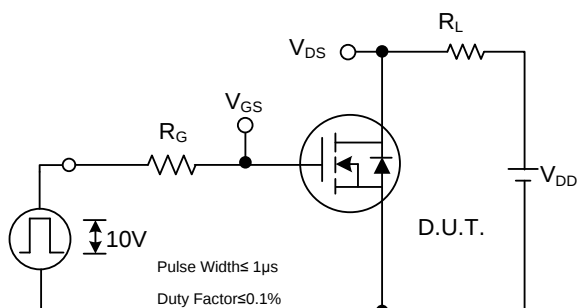


Peak Diode Recovery dv/dt Test Circuit

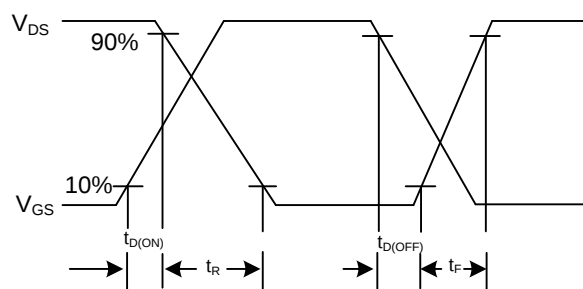


Peak Diode Recovery dv/dt Waveforms

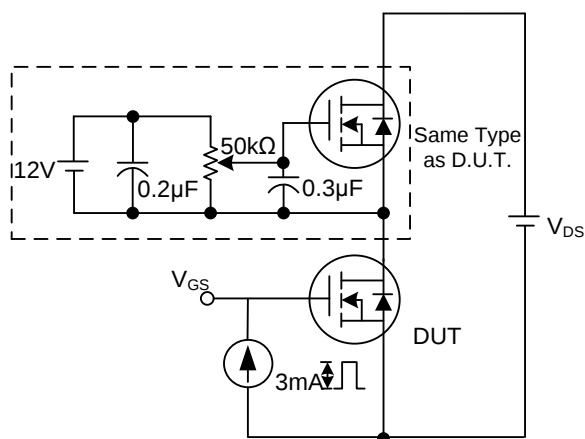
■ TEST CIRCUITS AND WAVEFORMS (Cont.)



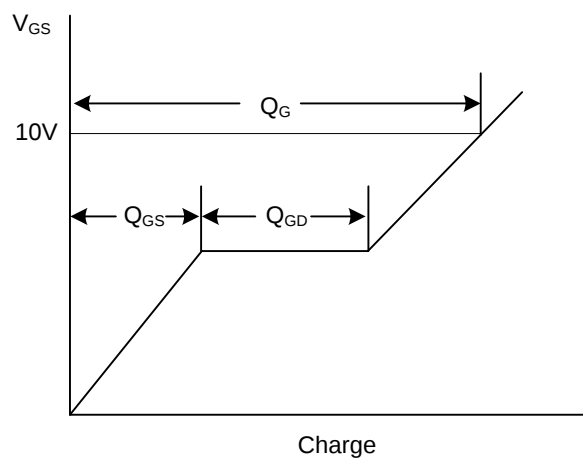
Switching Test Circuit



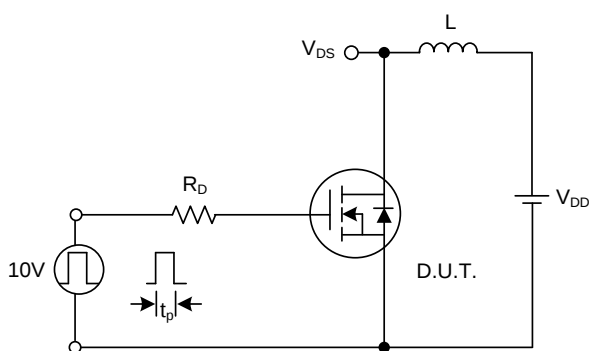
Switching Waveforms



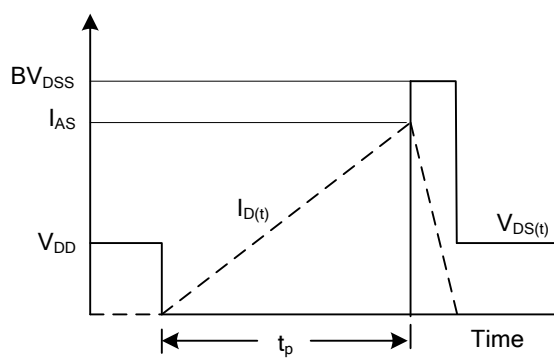
Gate Charge Test Circuit



Gate Charge Waveform



Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms

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